

# DATA SHEET

# SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

Automotive grade Array

NPO/X7R |6 V TO 50 V sizes 0508 (4 x 0402) / 0612 (4 x 0603)

RoHS compliant & Halogen Free



# YAGEO

#### YAGEO

Surface-Mount Ceramic Multilayer Capacitors Automotive Array NP0/X7R 16 V to 50 V

#### <u>SCOPE</u>

This specification describes Automotive grade NP0/X7R series chip capacitors with lead-free terminations and used for automotive equipments.

#### **APPLICATIONS**

- Professional electronics
- High density consumer electronics

#### FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- AC series soldering is compliant with J-STD-020D
- 0508 (4x0402) / 0612 (4x0603) capacitors (of the same capacitance value) per array
- Less than 50% board space of an equivalent discrete component
- Increased throughout, by time saved in mounting
- RoHS compliant & Halogen free
- The capacitors are 100% performed by automatic optical inspection prior to taping.

#### ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

### YAGEO BRAND ordering code GLOBAL PART NUMBER (PREFERRED)

#### AC <u>xxxx</u> <u>x</u> <u>x</u> <u>xxx</u> <u>x</u> B <u>x</u> <u>xxx</u> (1) (2) (3) (4) (5) (6) (7)

#### (I) SIZE - INCH BASED (METRIC)

0508 (1220) 0612 (1632)

#### (2) TOLERANCE

- J = ±5%
- $K = \pm 10\%$
- $M = \pm 20\%$

#### (3) PACKING STYLE

- R = Paper/PE taping reel; Reel 7 inch
- P = Paper/PE taping reel; Reel 13 inch

#### (4) TC MATERIAL

NPO

X7R

#### (5) RATED VOLTAGE

 $7 = 16 \vee$  $8 = 25 \vee$ 

## 9 = 50 V

#### (6) PROCESS

N = NP0B = class 2 material, X7R

#### (7) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example:  $|2| = |2 \times |0| = |20 \text{ pF}$ 



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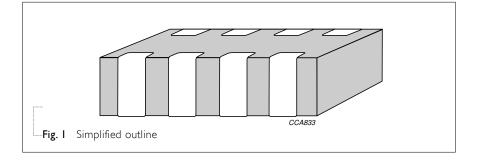
Surface-Mount Ceramic Multilayer Capacitors Automotive Array NP0/X7R 16 V to 50 V

#### **CONSTRUCTION**

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn).

The terminations are lead-free. An outline of the structure is shown in Fig. I.



#### OUTLINES

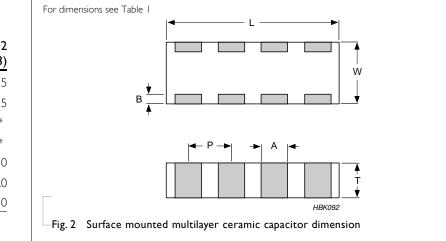


Table I For outlines see fig. 2

| ТҮРЕ                   | 0508<br>(4 X 0402) | 0612<br>(4 X 0603) |
|------------------------|--------------------|--------------------|
| L (mm)                 | 2.0 ±0.15          | 3.2 ±0.15          |
| W (mm)                 | 1.25 ±0.15         | 1.60 ±0.15         |
| T <sub>min.</sub> (mm) | *                  | *                  |
| T <sub>max.</sub> (mm) | *                  | *                  |
| A (mm)                 | 0.28 ±0.10         | 0.4 ±0.10          |
| B (mm)                 | 0.2 ±0.10          | 0.3 ±0.20          |
| P (mm)                 | 0.5 ±0.10          | 0.8 ±0.10          |

#### NOTE

\* Refer to Table 2 ~Table 3



| Table 2 Temperature characteristic material from NP0 |             |                 |                 |  |  |  |  |  |  |  |  |
|--|-------------|-----------------|-----------------|--|--|--|--|--|--|--|--|
|  |             | 0508 (4 × 0402) | 0612 (4 × 0603) |  |  |  |  |  |  |  |  |
|  | CAPACITANCE | 50 V            | 50 V            |  |  |  |  |  |  |  |  |
|  | I0 pF       | 0.6±0.1         | 0.8±0.1         |  |  |  |  |  |  |  |  |
|  | 15 pF       | 0.6±0.1         | 0.8±0.1         |  |  |  |  |  |  |  |  |
|  | 18 pF       | 0.6±0.1         | 0.8±0.1         |  |  |  |  |  |  |  |  |
|  | 22 pF       | 0.6±0.1         | 0.8±0.1         |  |  |  |  |  |  |  |  |

CAPACITANCE RANGE & THICKNESS FOR 4C-ARRAY

| 18 pF  | 0.6±0.1 | 0.8±0.1 |
|--------|---------|---------|
| 22 pF  | 0.6±0.1 | 0.8±0.1 |
| 33 pF  | 0.6±0.1 | 0.8±0.1 |
| 39 pF  | 0.6±0.1 | 0.8±0.1 |
| 47 pF  | 0.6±0.1 | 0.8±0.1 |
| 56 pF  | 0.6±0.1 | 0.8±0.1 |
| 68 pF  | 0.6±0.1 | 0.8±0.1 |
| 82 pF  | 0.6±0.1 | 0.8±0.1 |
| 100 pF | 0.6±0.1 | 0.8±0.1 |
| 120 pF |         | 0.8±0.1 |
| 150 pF |         | 0.8±0.1 |
| 180 pF |         | 0.8±0.1 |
| 220 pF |         | 0.8±0.1 |
| 270 pF |         | 0.8±0.1 |
| 330 pF |         | 0.8±0.1 |
| 390 pF |         | 0.8±0.1 |
| 470 pF |         | 0.8±0.1 |
| 560 pF |         |         |
| 680 pF |         |         |
| 820 pF |         |         |
| I.0 nF |         |         |

#### ΝΟΤΕ

Values in shaded cells indicate thickness class in mm



#### CAPACITANCE RANGE & THICKNESS FOR 4C-ARRAY

Table 3 Temperature characteristic material from X7R

| CAPACITANCE | 0508 (4 × 0402) |         |         | 0612 (4 × 0603) |         |         |
|-------------|-----------------|---------|---------|-----------------|---------|---------|
| _           | 16 V            | 25 V    | 50 V    | 16 V            | 25 V    | 50 V    |
| I.0 nF      | 0.6±0.1         | 0.6±0.1 | 0.6±0.1 | 0.8±0.1         | 0.8±0.1 | 0.8±0.1 |
| I.5 nF      | 0.6±0.1         | 0.6±0.1 |         | 0.8±0.1         | 0.8±0.1 | 0.8±0.1 |
| 2.2 nF      | 0.6±0.1         | 0.6±0.1 |         | 0.8±0.1         | 0.8±0.1 | 0.8±0.1 |
| 3.3 nF      | 0.6±0.1         | 0.6±0.1 |         | 0.8±0.1         | 0.8±0.1 | 0.8±0.1 |
| 4.7 nF      | 0.6±0.1         | 0.6±0.1 |         | 0.8±0.1         | 0.8±0.1 | 0.8±0.1 |
| 6.8 nF      | 0.6±0.1         | 0.6±0.1 |         | 0.8±0.1         | 0.8±0.1 | 0.8±0.1 |
| 10 nF       | 0.6±0.1         | 0.6±0.1 |         | 0.8±0.1         | 0.8±0.1 | 0.8±0.1 |
| 22 nF       | 0.6±0.1         |         |         |                 |         |         |
| 47 nF       | 0.6±0.1         |         |         | 0.8±0.1         | 0.8±0.1 |         |
| 100 nF      | 0.6±0.1         |         |         |                 |         |         |

#### ΝΟΤΕ

Values in shaded cells indicate thickness class in mm

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#### THICKNESS CLASSES AND PACKING QUANTITY

| Table 4 |                |                   |                             |         |        |         |  |  |
|---------|----------------|-------------------|-----------------------------|---------|--------|---------|--|--|
| SIZE    | THICKNESS      |                   | TAPE WIDTH Ø180 MM / 7 INCH |         |        |         |  |  |
| CODE    | CLASSIFICATION | QUANTITY PER REEL | Paper                       | Blister | Paper  | Blister |  |  |
| 0508    | 0.6 ±0.1 mm    | 8 mm              | 4,000                       |         | 20,000 |         |  |  |
| 0612    | 0.8 ±0.1 mm    | 8 mm              | 4,000                       |         | 15,000 |         |  |  |

#### ELECTRICAL CHARACTERISTICS

#### NP0/X7R DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

| Table 5                |                       |                     |
|------------------------|-----------------------|---------------------|
| DESCRIPTION            |                       | VALUE               |
| Capacitance range      |                       | 10 pF to 100 nF     |
| Capacitance tolerance  | 2                     |                     |
| NP0                    | C ≥ 10 pF             | ±5%                 |
| X7R                    |                       | ±10%, ±20%          |
| Dissipation factor (D. | F.)                   |                     |
| NP0                    | C < 30 <sub>P</sub> F | ≤ I / ( 400 + 20C ) |
|                        | C ≥ 30 pF             | ≤ 0.1%              |
|                        |                       |                     |

| X7R               | 0508<br>(Array)                              | 0612<br>(Array)                           |                      |
|-------------------|--|---|----------------------|
| 16V               | InF to IOnF                                  | 220pF to 47nF                             | ≤ 3.5%               |
|                   | I5nF to I00nF                                |   | ≤ 5%                 |
| 25V               | InF to IOnF                                  | 220pF to 47nF                             | ≤ 2.5%               |
| 50V               | InF  | 220pF to 10nF                             | ≤ 2.5%               |
| Insulation resist | ance after I minute  at  U <sub>r</sub> (DC) | IR ≥ 10G $\Omega$ or I.R × C ≥ 500 second | ls whichever is less |



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Surface-Mount Ceramic Multilayer Capacitors Automotive Array NP0/X7R 16 V to 50 V

#### SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds •
- ٠ Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

#### TESTS AND REQUIREMENTS

| TEST                            | TEST METH           | IOD   | PROCEDURE   | REQUIREMENTS  |
|---------------------------------|---------------------|-------|---|---|
| Mounting                        | IEC 60384-<br>21/22 | 4.3   | The capacitors may be mounted on printed-circuit boards or ceramic substrates   | No visible damage   |
| Capacitance                     | IEC 60384-<br>21/22 | 4.5.1 | Class I:<br>At 20 °C, 24 hours after annealing<br>$f = 1$ MHz for $C \le InF$ , measuring at voltage 1 V <sub>rms</sub> at 20 °C<br>f = 1 KHz for $C > InF$ , measuring at voltage 1 V <sub>rms</sub> at 20 °C<br>Class 2:<br>At 20 °C, 24 hours after annealing<br>f = 1 KHz, measuring at voltage 1 V <sub>rms</sub> at 20 °C | Within specified tolerance  |
| Dissipation<br>Factor (D.F.)    | IEC 60384-<br>21/22 | 4.5.2 | Class I:<br>At 20 °C, 24 hours after annealing<br>$f = 1$ MHz for $C \le InF$ , measuring at voltage 1 V <sub>rms</sub> at 20 °C<br>f = 1 KHz for $C > InF$ , measuring at voltage 1 V <sub>rms</sub> at 20 °C<br>Class 2:<br>At 20 °C, 24 hours after annealing<br>f = 1 KHz, measuring at voltage 1 V <sub>rms</sub> at 20 °C | In accordance with specification  |
| Insulation<br>Resistance        | IEC 60384-<br>21/22 | 4.5.3 | At U <sub>r</sub> (DC) for 1 minute   | In accordance with specification  |
| High<br>Temperature<br>Exposure | AEC-Q200            | 3     | Unpowered ; 1000hours @ T=150° <b>C</b><br>Measurement at 24±2 hours after test conclusion.   | No visual damage<br>$\Delta C/C$ :<br>Class I:<br>NP0: within ±0.5% or 0.5 pF<br>whichever is greater<br>Class2:<br>X7R: ±10%<br>D.F.:<br>within initial specified value<br>IR:<br>within initial specified value |

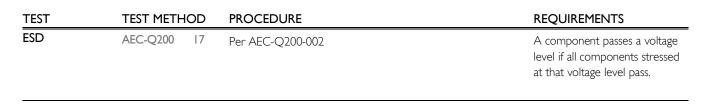


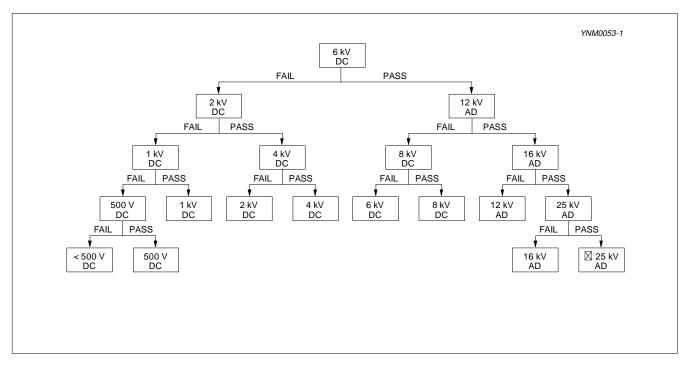
| TEST                             | TEST METH | HOD | PROCEDURE  | REQUIREMENTS   |
|----------------------------------|-----------|-----|--|--|
| Temperature<br>Cycling           | AEC-Q200  | 4   | Preconditioning;<br>150 +0/–10 °C for 1 hour, then keep for  | No visual damage   |
|                                  |           |     | <ul> <li>24 ±1 hours at room temperature</li> <li>1000 cycles with following detail:</li> <li>30 minutes at lower category temperature</li> <li>30 minutes at upper category temperature</li> <li>Recovery time 24 ±2 hours</li> </ul> | $\Delta$ C/C<br>Class I:<br>NP0: Within ±1% or 0.5pF,<br>whichever is greater.<br>Class2:<br>X7R: ±10% |
|                                  |           |     |  | D.F. meet initial specified value<br>IR meet initial specified value                                   |
| Destructive<br>Physical Analysis | AEC-Q200  | 5   | Note: Only applies to SMD ceramics.<br>Electrical test not required.   |  |
| Moisture<br>Resistance           | AEC-Q200  | 6   | T=24 hrs/per cycle; 10 continuous cycles unpowered.<br>Measurement at 24 ±2 hours after test condition.  | No visual damage   |
|                                  |           |     |  | $\Delta$ C/C<br>NP0: Within ±3% or 3 pF,<br>whichever is greater<br>X7R: ±15%                          |
|                                  |           |     |  | D.F.<br>Within initial specified value<br>IR<br>NP0: ≥ 10,000 MΩ<br>X7R: Meet initial specified value  |

| Г                     | Т     | Т      | Т    | Т            | Т         | П           |      |           |               |      |        |     |     |     |     |     | Г            | Г            |      |           |      |          |           |      |          |            |     |     |            | Г        | Т        |
|-----------------------|-------|--------|------|--------------|-----------|-------------|------|-----------|---------------|------|--------|-----|-----|-----|-----|-----|--------------|--------------|------|-----------|------|----------|-----------|------|----------|------------|-----|-----|------------|----------|----------|
| L.                    |       | $^{+}$ | +    | +            | +         | $\square$   |      |           |               |      |        |     |     | 80  | -10 | 07  | +            |              |      |           |      |          |           |      |          |            |     |     |            | t        | $^{+}$   |
| 70                    | 1     | T      | INI  | TIAL         | . co      | N-          |      |           | _             | 90-  | 100    | X R | н   | _   | RH  |     |              | 90           | 0-10 | 07        | RH   | _        |           | _    | 8        | 0-1        | 007 | RH  |            | <u> </u> | _        |
| 6                     | - I - |        | DIT  | IONI<br>RY ( | ING       | IN          |      |           |               |      | Π      |     |     | Ń   |     |     | 1            | Г            |      |           |      | Ń        |           |      |          |            |     |     |            | Г        | Т        |
| 6                     |       |        | 24   | HOUP         | RS        | ' '         |      |           |               |      | -      |     | -   |     |     |     | +            |              | 1    |           |      | N        |           |      |          |            |     |     |            | t        | ╈        |
| 5                     |       | ╈      |      | 6            | _         | Γ           |      | H         |               | 1    |        |     |     |     |     |     | +            | 17           |      |           |      |          | $\square$ |      |          |            |     |     |            | t        | +        |
| 50                    | 1     | t      |      | -p:          | 7         | ħ           |      |           |               | 1    |        |     | -   | _   | М   |     | +            | Ħ            |      |           |      |          | ٦         |      |          |            |     |     |            | t        | $^{+}$   |
| 4                     |       | 1:     | JNCO | DIT          | Y<br>Olle | Ы           |      |           |               | /    |        |     | -   |     | N   |     | +            | ᡟ            |      |           |      |          | N         |      | +        | -          |     |     |            | t        | $^+$     |
| 41                    |       | +      | Т    | T            | Т         |             |      | $\square$ |               |      |        |     | -   | _   |     |     | $\mathbf{t}$ |              |      |           |      |          |           |      | +        | -          |     |     |            | t        | $^+$     |
| 3:                    |       | $^{+}$ | +    | +            | +         | H           |      | $\square$ | 1             |      |        |     | +   |     |     | ٢   | Ħ            |              |      | $\square$ | _    |          |           | H    | +        | EN         | 0 0 | FF  | INA        | AL.      | CY       |
| 30                    |       | $^+$   | +    | +            | +         | H           |      |           | $\mathcal{H}$ |      |        |     | -+  |     |     | 7   | 1/           | +            |      |           | _    |          |           | Y    | $\neg$   | ME/<br>SPI | ASU | REM | ENT<br>D I | TS<br>En | AS<br>3. |
| 25                    |       | $^+$   | +    | +            | +         | 1-          | 55   | Η         | +             |      |        |     | +   |     |     |     | 0°C          |              |      | H         |      |          |           |      | +        | 55         |     |     |            | K        | Ť        |
| 20                    |       | Τ,     |      | 7.41         | MEA       | SURE        | MEN  | 170       |               |      | -      |     | -   | _   |     | -   | 2.0          |              |      | $\square$ |      |          |           |      | +        | -1         |     |     |            | ħ        | Xt       |
|                       | 5     | ٦Å     | SS   | PECI         | FIE       | DIN         | 3    | z         |               |      |        |     | +   |     |     |     | 1            | +            |      | H         |      |          |           |      | +        |            |     |     |            | Ħ        | h        |
| 10                    | 아     | $^{+}$ | Т    | Т            | Г         |             |      |           |               |      |        |     | +   |     |     |     | +            | +            |      | H         |      |          |           |      |          |            |     |     |            | t        | H        |
|                       | 5     | $^+$   | +    | +            | +         | $\square$   |      | H         | -             |      | VOL    | TAG | EA  | PPL | IEC | A   | \s s         | PEC          | IFI  | ED 1      | (N ) | 3.5      | _         |      |          | 1          |     |     |            | Ħ        | H        |
|                       | 아     | $^+$   | +    | +            | +         | $\vdash$    | _    | $\square$ |               |      |        |     |     |     |     |     | T            | T            |      |           |      |          |           |      |          | 1          |     |     |            | Ħ        | H        |
| -+                    | 5     | $^+$   | +    | +            | +         | $\vdash$    |      | $\square$ |               |      |        |     | +   |     |     | s   | TEP          | S 7          | 8    | 7b (      | IF   | APP      | LIC       | ABLI | E)       | 1          |     |     | -          | H        | ╞╪       |
| -10                   | 아     | +      | +    | +            | +         | $\vdash$    |      |           |               |      | $\neg$ |     | +   | _   |     | 5   | HAL          | L 81<br>TH   | E PE | RFO       | RME  | DA<br>S. | MI        | NIM  | UM<br>TY | OF  <br>IS | -   |     | -          | Ľ        | +        |
| -                     | +     | +      | +    | +            | +         | $\vdash$    | _    | $\square$ |               |      | -      |     | +   | -   |     | U   | NCO          | NTR          | DLLE | D D<br>7ь | URI  | NG       |           |      |          | -          | _   |     |            | ┢        | +        |
| -                     | +     | +      | +    | +            | +         | $\vdash$    | _    | $\square$ |               |      | -      |     | -   |     |     |     | T            | <u>1 – 1</u> | 1    | ŕ         | UNL  | ί Π      |           |      |          | -          | _   |     |            | ⊢        | +        |
| -                     | +     | ┢      | RIO  | RT           | DFI       | RST         | CY   | CLE       | ST            | EP 1 |        | STE | , 2 | 15  | TEP | , 3 | 1 51         | TEP          | 41   | STE       | P 5  | IS       | TEP       | 61   |          |            | s   | TEP | , 7        | -        | -        |
|                       | +     | Ľ      | INLĒ | SS (         | DTHE      | RWIS<br>IED | SE . |           |               | _    | +      | _   | -   |     | CLE | -   |              |              |      |           | _    |          | _         | ECI  | FTF      | ד ת        | -   | _   | -          |          |          |
|                       | +     | f      |      | T            | T         |             |      |           |               |      |        |     |     |     |     | -   | 1            | Ī            | Í    |           | -    |          |           |      |          | 1          | 1   |     |            | Γ        | T        |
| L                     | -     | +      | -    |              | -         |             |      |           | _             |      | _      |     | -   | _   |     | -   | -            |              | -    |           |      |          |           | _    | -        | -          |     |     |            | -        | -        |
| A Maintana anaistant  |       |        |      |              |           |             |      |           |               |      |        |     |     |     |     |     |              |              |      |           |      |          |           |      |          |            |     |     |            |          |          |
| .4 Moisture resistant |       |        |      |              |           |             |      |           |               |      |        |     |     |     |     |     |              |              |      |           |      |          |           |      |          |            |     |     |            |          |          |

| TEST                  | TEST METH | IOD | PROCEDURE  | REQUIREMENTS   |
|-----------------------|-----------|-----|--|--|
| Biased Humidity       | AEC-Q200  | 7   | <ul> <li>I. Preconditioning, class 2 only:</li> <li>150 +0/-10 °C /1 hour, then keep for</li> <li>24 ±1 hour at room temp</li> </ul>   | No visual damage after<br>recovery   |
|                       |           |     | <ol> <li>Initial measure:<br/>Parameter: IR<br/>Measuring voltage: 1.5V ± 0.1 VDC<br/>Note: Series with 100 KΩ</li> <li>Test condition:<br/>85 °C, 85% R.H. connected with 100 KΩ resistor, applied<br/>1.5V/U<sub>r</sub> for 1,000 hours.</li> </ol> | Initial requirement:<br>Class I:<br>- Connected to 100 K $\Omega$ :<br>C $\leq$ 10 nF: I.R $\geq$ 10,000 M $\Omega$<br>or<br>C $\geq$ 10 nF: (I.R-100 K $\Omega$ ) $\times$ C          |
|                       |           |     | <ul> <li>4. Recovery:<br/>Class I: 6 to 24 hours<br/>Class 2: 24 ±2 hours</li> <li>5. Final measure: IR</li> </ul>   | ≥ 100s.<br>Class2:<br>- Connected to 100 KΩ:<br>C ≤ 25 nF: I.R ≥ 4,000 MΩ or   |
|                       |           |     |  | C > 25 nF: (I.R-100 KΩ) × C<br>≥ 100s.   |
|                       |           |     |  | Final measurement:<br>The insulation resistance shall<br>be greater than 0.1 time initial<br>value.  |
| Operational Life      | AEC-Q200  | 8   | 1. Preconditioning, class 2 only:<br>150 +0/-10 °C /1 hour, then keep for  | No visual damage   |
|                       |           |     | <ul><li>24 ±1 hour at room temp</li><li>2. Initial measure:</li><li>Spec: refer to initial spec C, D, IR</li></ul>   | $\Delta C/C$<br>NP0: Within ±2% or 1 pF,<br>whichever is greater<br>X7R: ±15%  |
|                       |           |     | 3. Endurance test:<br>Temperature: X7R: 125 °C   | D.F.   |
|                       |           |     | <ul> <li>Specified stress voltage applied for 1,000 hours:<br/>Applied 2.0 × U<sub>r</sub> s</li> <li>4. Recovery time: 24 ±2 hours</li> <li>5. Final measure: C, D, IR</li> </ul>   | NP0: $\leq 2 \times$ specified value.<br>X7R: $\leq 16V$ : $\leq 7\%$ or specified<br>value whichever is greater<br>$\geq 25V$ : $\leq 5\%$ or specified<br>value whichever is greater |
|                       |           |     | Note: If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to <i>"IEC 60384 4.1"</i> and then the requirement shall be met.             | IR<br>NP0: $\geq$ 4,000 M $\Omega$ or IR x C <sub>r</sub> $\geq$<br>40s whichever is less<br>X7R: $\geq$ 1,000 M $\Omega$ or IRx C <sub>r</sub> $\geq$<br>50s whichever is less        |
| External Visual       | AEC-Q200  | 9   | Any applicable method using × 10 magnification   | In accordance with specification   |
| Physical<br>Dimension | AEC-Q200  | 10  | Verify physical dimensions to the applicable device specification.   | In accordance with specification   |

| TEST                            | TEST METH | IOD | PROCEDURE   | REQUIREMENTS  |  |  |  |
|---------------------------------|-----------|-----|---|---|--|--|--|
| Mechanical<br>Shock             | AEC-Q200  | 13  | Three shocks in each direction shall be applied along the<br>three mutually perpendicular axes of the test specimen (18<br>shocks)<br>Peak value: 1,500 g's<br>Duration: 0.5 ms<br>Velocity change: 15.4 ft/s<br>Waveform: Half-sin   | ΔC/C<br>NP0: Within ±0.5% or 0.5 pF,<br>whichever is greater<br>X7R: ±10%<br>D.F.<br>Within initial specified value<br>IR<br>Within initial specified value   |  |  |  |
| Vibration                       | AEC-Q200  | 14  | 5 g's for 20 minutes, 12 cycles each of 3 orientations.   | ΔC/C<br>NP0: Within ±0.5% or 0.5 pF,<br>whichever is greater<br>X7R: ±10%   |  |  |  |
|                                 |           |     |   | D.F: meet initial specified value<br>IR meet initial specified value  |  |  |  |
| Resistance to<br>Soldering Heat | AEC-Q200  | 15  | Precondition: $150 \pm 0/-10$ °C for 1 hour, then keep for 24<br>±1 hours at room temperature<br>Preheating: 120 °C to 150 °C for 1 minute<br>Solder bath temperature: 260 ±5 °C<br>Dipping time: 10 ±0.5 seconds<br>Recovery time: 24 ±2 hours   | Dissolution of the end face<br>plating shall not exceed 25% of<br>the length of the edge<br>concerned<br>$\Delta C/C$ Class I:<br>NP0: Within ±1% or 0.5 pF,<br>whichever is greater.<br>Class2:<br>X7R: ±10% |  |  |  |
|                                 |           |     |   | D.F. within initial specified value<br>IR within initial specified value  |  |  |  |
| Thermal Shock                   | AEC-Q200  | 16  | <ol> <li>Preconditioning, class 2 only:<br/>150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room a<br/>temp</li> <li>Initial measure:<br/>Spec: refer to initial spec C, D, IR</li> <li>Rapid change of temperature test:<br/>NP0/X7R: -55 °C to +125 °C; 300 cycles<br/>15 minutes at lower category temperature; 15 minutes at<br/>upper category temperature.</li> <li>Recovery time:<br/>Class1: 6 to 24 hours<br/>Class2: 24 ±2 hours</li> <li>Final measure: C, D, IR</li> </ol> | No visual damage<br>$\Delta C/C$<br>NP0: Within ±1% or 1 pF,<br>whichever is greater<br>X7R: ±15%<br>D.F: meet initial specified value<br>IR meet initial specified value                                     |  |  |  |





| Solderability | AEC-Q200 | 18 | <ol> <li>Preheat at 155°C for 4 hours. After preheating, immerse<br/>the capacitor in a solution of ethanol and rosin (25% rosin<br/>in weight proportion). Immerse in eutectic solder solution<br/>for 5+0/-0.5 seconds at 235±5°C.</li> </ol>                                 | The solder should cover over<br>95% of the critical area of each<br>termination. |  |
|---------------|----------|----|---|--|--|
|               |          |    | <ol> <li>Should be placed into steam aging for 8 hours±15 minutes.<br/>After preheating, immerse the capacitor in a solution of<br/>ethanol and rosin (25% rosin in weight proportion).<br/>Immerse in eutectic solder solution for 5+0/-0.5 seconds<br/>at 235±5°C.</li> </ol> |  |  |
|               |          |    | 3. Should be placed into steam aging for 8 hours±15 minutes.<br>After preheating, immerse the capacitor in a solution of<br>Ethanol and rosin (25% rosin in weight proportion).<br>Immerse in eutectic solder solution for 120±5 seconds at<br>260±5°C.                         |  |  |

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| TEST                           | TEST METHOD |    | PROCEDURE  | <b>REQUIREMENTS</b> ΔC/CClass 1:NP0: ±30 ppm/°CClass2:X7R: ±15%  |  |
|--------------------------------|-------------|----|--|--|--|
| Electrical<br>Characterization | AEC-Q200 19 |    | Parametrically test per lot and sample size requirements,<br>summary to show Min, Max, Mean and Standard deviation at<br>room as well as Min and Max operating temperatures.<br>Class 1:<br>NP0: -55 °C to +125 °C<br>Normal temperature: 20 °C<br>Class 2:<br>X7R: -55 °C to +125 °C<br>Normal temperature: 20 °C |  |  |
| Board Flex AEC-Q200 21         |             | 21 | Part mounted on a 100 mm X 40 mm FR4 PCB board, which<br>is 1.6 ±0.2 mm thick<br>Part should be mounted using the following soldering reflow<br>profile.<br>Conditions:<br>Class I:<br>Bending 3 mm at a rate of 1 mm/s, radius jig 340 mm<br>Class2:<br>Bending 2 mm at a rate of 1 mm/s, radius jig 340 mm       | No visible damage<br>$\Delta C/C$<br>Class I:<br>NP0: Within ±1% or 0.5 pF,<br>whichever is greater<br>Class2:<br>X7R: ±10%  |  |
| Terminal<br>Strength           | AEC-Q200    | 22 | With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested.<br>This force shall be applied for 60+1 seconds.<br>Also the force shall be applied gradually as not to apply a shock to the component being tested.                  | Magnification of 20X or greater<br>may be employed for inspection<br>of the mechanical integrity of<br>the device body, terminals and<br>body/terminal junction.<br>Before and after the test, the<br>device shall comply with all<br>electrical requirements stated in<br>this specification. |  |
| Beam Load Test                 | AEC-Q200    | 23 | Place the part in the beam load fixture. Apply a force until<br>the part breaks or the minimum acceptable force level<br>required in the user specification(s) is attained.  | 0508: 20N<br>0612: 15N   |  |
| Voltage Proof                  |             |    | 1. Specified stress voltage applied for $1 \sim 5$ seconds<br>2. Ur $\leq 100$ V: applied 2.5 Ur   | No breakdown or flashover  |  |
|                                |             |    | Charge/Discharge current is less than 50 mA  |  |  |

## <u>REVISION HISTORY</u>

| REVISION  | DATE           | CHANGE NOTIFICATION | DESCRIPTION     |
|-----------|----------------|---------------------|-----------------|
| Version 0 | July 09, 202 I | -                   | - New Datasheet |

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